

## AMPMODU | AMPMODU 50/50 Grid

TE Internal #: 104894-9

AMPMODU 50/50 Grid, PCB Mount Header, Right Angle, Board-to-

Board, 90 Position, 1.27mm [.05in] Centerline, Fully Shrouded,

Gold, Printed Circuit Board

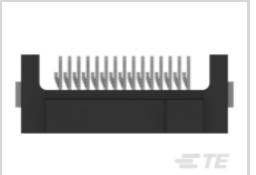
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Connectors > PCB Connectors > Board-to-Board Connectors > Board-to-Board Headers & Receptacles











PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Right Angle Connector System: Board-to-Board

Number of Positions: 90

Centerline (Pitch): 1.27 mm [ .05 in ]

### **Features**

# Product Type Features

| PCB Connector Assembly Type       | PCB Mount Header      |
|-----------------------------------|-----------------------|
| Connector System                  | Board-to-Board        |
| Header Type                       | Fully Shrouded        |
| Sealable                          | No                    |
| Connector & Contact Terminates To | Printed Circuit Board |
| Configuration Features            |                       |
| Number of Rows                    | 2                     |
| Connector Contact Load Condition  | Fully Loaded          |

# **Electrical Characteristics**

Number of Positions

PCB Mount Orientation

| Dielectric Withstanding Voltage (Max) | 300 VAC |
|---------------------------------------|---------|
| Operating Voltage                     | 30 VAC  |

Right Angle

90

## **Body Features**



| PCB Retention Feature Material                | Copper Alloy         |
|---|----------------------|
| PCB Retention Feature Plating Material        | Tin-Lead over Nickel |
| Connector Profile                             | Standard             |
| Contact Features                              |                      |
|   | 150 μin              |
| Mating Pin Diameter                           | .46 mm[.018 in]      |
| Contact Shape & Form                          | Square               |
| Contact Underplating Material                 | Nickel               |
| PCB Contact Termination Area Plating Material | Tin-Lead             |
| Contact Base Material                         | Brass                |
| Contact Mating Area Plating Material          | Gold                 |
| Contact Type                                  | Pin                  |
| Contact Current Rating (Max)                  | .5 A                 |
| Termination Features                          |                      |
| Round Termination Post & Tail Diameter        | .46 mm[.018 in]      |
| Termination Method to Printed Circuit Board   | Surface Mount        |
| Mechanical Attachment                         |                      |
| PCB Mount Retention Type                      | Hold-Down Post       |
| Mating Alignment                              | With                 |
| Mating Alignment Type                         | Keyed                |
| PCB Mount Retention                           | With                 |
| Housing Features                              |                      |
| Centerline (Pitch)                            | 1.27 mm[.05 in]      |
| Housing Color                                 | Black                |
| Housing Material                              | Thermoplastic        |
| Dimensions                                    |                      |
| Row-to-Row Spacing                            | 1.27 mm[.05 in]      |
| Usage Conditions                              |                      |
| Operating Temperature Range                   | -65 – 105 °C         |
| Operation/Application                         |                      |
| Solder Process Feature                        | Board Standoff       |
|   |                      |



## **Industry Standards**

| Approved Standards     | CSA LR7189, UL E28476 |
|------------------------|-----------------------|
| UL Flammability Rating | UL 94V-0              |
| Packaging Features     |                       |
| Packaging Quantity     | 7                     |
| Packaging Method       | Box & Tube, Tube      |

# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU                  | Not Compliant   |
|---|---|
| EU ELV Directive 2000/53/EC                   | Not Compliant   |
| China RoHS 2 Directive MIIT Order No 32, 2016 | Restricted Materials Above Threshold  |
| EU REACH Regulation (EC) No. 1907/2006        | Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211) SVHC > Threshold: Pb (40% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location. |
| Halogen Content                               | Low Halogen - Br, Cl, F, I < 900 ppm per<br>homogenous material. Also BFR/CFR/PVC<br>Free   |
| Solder Process Capability                     | Reflow solder capable to 260°C  |

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Also in the Series | AMPMODU 50/50 Grid





Board-to-Board Headers & Receptacles(290)



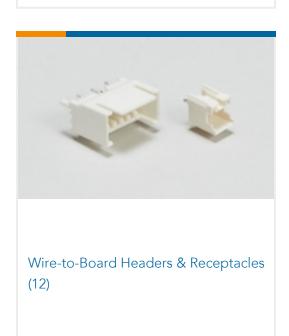
Insertion & Extraction Tools(1)



PCB Connector Covers(9)



Ribbon Cable Connectors(34)



# Customers Also Bought



RN 0805 1K4 0.1% 10PPM 5KRL



RN 0805 9K09 0.1% 10PPM 5KRL

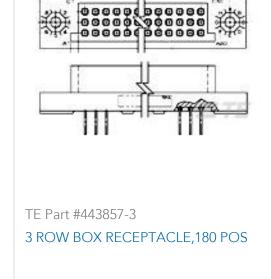


JMGSC-5MW = M39016/41-049M



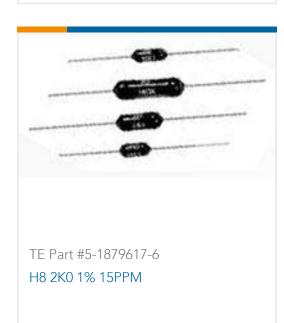














## **Documents**



## **Product Drawings**

90 50/50 GRID RA HDR

English

#### **CAD Files**

**Customer View Model** 

ENG\_CVM\_104894-9\_J.3d\_stp.zip

English

**Customer View Model** 

ENG\_CVM\_104894-9\_J.2d\_dxf.zip

English

3D PDF

English

**Customer View Model** 

ENG\_CVM\_104894-9\_J.3d\_igs.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

# **Product Specifications**

**Application Specification** 

English

# Agency Approvals

**UL Report** 

English